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# System Clock for Embedded AMD™ based Systems

**9EPRS475**
**Recommended Application:**

AMD M690T/780E systems

- 2 - Greyhound compatible K8 CPU pair
  - 4 - low-power differential SRC pairs
  - 2 - low-power differential SouthBridge SRC pairs
  - 3 - low-power differential ATIG pairs
  - 1 - Selectable 100MHz low-power differential/ 66 MHz single-ended HTT clock
  - 2 - 48MHz USB clock
  - 3 - 14.318MHz Reference clock
- CPU outputs cycle-to-cycle jitter < 150ps
  - SRC outputs cycle-to-cycle jitter < 125ps
  - ATIG outputs cycle-to-cycle jitter < 125ps
  - +/- 300ppm frequency accuracy on CPU, SRC & ATIG clocks
- Spread Spectrum for EMI reduction
  - Outputs may be disabled via SMBus
  - External crystal load capacitors for maximum frequency accuracy
  - PCI Express Generation 2.0 compliant

48MHz_1	1	<b>9EPRS475</b>	56	VDD48
48MHz_0	2		55	X2
GND48	3		54	X1
SMBCLK	4		53	GNDREF
SMBDAT	5		52	VDDREF
SRC3C_LPRS	6		51	REF0/SEL_HTT66
SRC3T_LPRS	7		50	REF1
SRC2C_LPRS	8		49	REF2
SRC2T_LPRS	9		48	VDDHTT
GNDSRC	10		47	HTT0T_LPRS/66M
VDDSRC	11		46	HTT0C_LPRS/66M
SRC1C_LPRS	12		45	GNDHTT
SRC1T_LPRS	13		44	RESTORE#
VDDSRC	14		43	PD#
GNDSRC	15		42	CPUKG0T_LPRS
SRC0C_LPRS	16		41	CPUKG0C_LPRS
SRC0T_LPRS	17		40	VDDCPU
SB_SRC1C_LPRS	18		39	GNDCPU
SB_SRC1T_LPRS	19		38	CPUKG1T_LPRS
GNDSB_SRC	20		37	CPUKG1C_LPRS
VDDSB_SRC	21		36	VDDA
SB_SRC0C_LPRS	22		35	GNDA
SB_SRC0T_LPRS	23		34	GND
GNDATIG	24		33	VDD
ATIG2C_LPRS	25		32	ATIG0T_LPRS
ATIG2T_LPRS	26		31	ATIG0C_LPRS
GNDATIG	27		30	ATIG1T_LPRS
VDDATIG	28		29	ATIG1C_LPRS

**56-Pin TSSOP**

## Pin Description

PIN #	PIN NAME	TYPE	DESCRIPTION
1	48MHz_1	OUT	48MHz clock output.
2	48MHz_0	OUT	48MHz clock output.
3	GND48	GND	Ground pin for the 48MHz outputs
4	SMBCLK	IN	Clock pin of SMBus circuitry, 5V tolerant.
5	SMBDAT	I/O	Data pin for SMBus circuitry, 5V tolerant.
6	SRC3C_LPRS	OUT	Complement clock of low power differential SRC clock pair. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
7	SRC3T_LPRS	OUT	True clock of low power differential SRC clock pair. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
8	SRC2C_LPRS	OUT	Complement clock of low power differential SRC clock pair. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
9	SRC2T_LPRS	OUT	True clock of low power differential SRC clock pair. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
10	GNDSRC	GND	Ground pin for the SRC outputs
11	VDDSRC	PWR	Supply for SRC core, 3.3V nominal
12	SRC1C_LPRS	OUT	Complement clock of low power differential SRC clock pair. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
13	SRC1T_LPRS	OUT	True clock of low power differential SRC clock pair. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
14	VDDSRC	PWR	Supply for SRC core, 3.3V nominal
15	GNDSRC	GND	Ground pin for the SRC outputs
16	SRC0C_LPRS	OUT	Complement clock of low power differential SRC clock pair. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
17	SRC0T_LPRS	OUT	True clock of low power differential SRC clock pair. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
18	SB_SRC1C_LPRS	OUT	Complement clock of low power differential SouthBridge SRC clock pair. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
19	SB_SRC1T_LPRS	OUT	True clock of low power differential SouthBridge SRC clock pair. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
20	GND_SB_SRC	GND	Ground pin for the SB_SRC outputs
21	VDD_SB_SRC	PWR	Supply for SRC core, 3.3V nominal
22	SB_SRC0C_LPRS	OUT	Complement clock of low power differential SouthBridge SRC clock pair. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
23	SB_SRC0T_LPRS	OUT	True clock of low power differential SouthBridge SRC clock pair. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
24	GNDATIG	GND	Ground pin for the ATIG outputs
25	ATIG2C_LPRS	OUT	Complementary clock of low-power differential push-pull ATIG pair with integrated series resistor. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
26	ATIG2T_LPRS	OUT	True clock of low-power differential push-pull ATIG pair with integrated series resistor. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
27	GNDATIG	GND	Ground pin for the ATIG outputs
28	VDDATIG	PWR	Power supply for ATIG core, nominal 3.3V
29	ATIG1C_LPRS	OUT	Complementary clock of low-power differential push-pull ATIG pair with integrated series resistor. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
30	ATIG1T_LPRS	OUT	True clock of low-power differential push-pull ATIG pair with integrated series resistor. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)

## Pin Description (Continued)

PIN #	PIN NAME	TYPE	DESCRIPTION
31	ATIG0C_LPRS	OUT	Complementary clock of low-power differential push-pull ATIG pair with integrated series resistor. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
32	ATIG0T_LPRS	OUT	True clock of low-power differential push-pull ATIG pair with integrated series resistor. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed)
33	VDD	PWR	Power supply, nominal 3.3V
34	GND	GND	Ground pin
35	GNDA	GND	Ground for the Analog Core
36	VDDA	PWR	3.3V Power for the Analog Core
37	CPUKG1C_LPRS	OUT	Complementary signal of low-power differential push-pull AMD K8 "Greyhound" clock with integrated series resistor. (no 33 ohm series resistor needed)
38	CPUKG1T_LPRS	OUT	True signal of low-power differential push-pull AMD K8 "Greyhound" clock with integrated series resistor. (no 33 ohm series resistor needed)
39	GNDCPU	GND	Ground pin for the CPU outputs
40	VDDCPU	PWR	Supply for CPU core, 3.3V nominal
41	CPUKG0C_LPRS	OUT	Complementary signal of low-power differential push-pull AMD K8 "Greyhound" clock with integrated series resistor. (no 33 ohm series resistor needed)
42	CPUKG0T_LPRS	OUT	True signal of low-power differential push-pull AMD K8 "Greyhound" clock with integrated series resistor. (no 33 ohm series resistor needed)
43	PD#	IN	Enter /Exit Power Down. 0 = Power Down, 1 = normal operation.
44	RESTORE#	I/O	Open Drain I/O. As an input it restores the PLL's to power up default state. As an output, this signal is driven low when the internal watchdog hardware timer expires. It is cleared when the internal watchdog hardware timer is reset or disabled. The input is falling edge triggered. 0 = Restore Settings, 1 = normal operation.
45	GNDHTT	PWR	Ground pin for the HTT outputs
46	HTT0C_LPRS/66M	OUT	Complementary signal of low-power differential push-pull hypertransport clock with integrated series resistor. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed) / 3.3V single ended 66MHz hyper transport clock
47	HTT0T_LPRS/66M	OUT	True signal of low-power differential push-pull hypertransport clock with integrated series resistor. (no 50ohm shunt resistor to GND and no 33 ohm series resistor needed) / 3.3V single ended 66MHz hyper transport clock
48	VDDHTT	PWR	Supply for HTT clocks, nominal 3.3V.
49	REF2	OUT	14.318 MHz reference clock, 3.3V
50	REF1	OUT	14.318 MHz 3.3V reference clock
51	REF0/SEL_HTT66	I/O	14.318 MHz 3.3V reference clock./ 3.3V tolerant latched input to select Hyper Transport Clock Frequency. 0 = 100MHz differential HTT clock, 1 = 66MHz 3.3V single ended HTT clock
52	VDDREF	PWR	Ref, XTAL power supply, nominal 3.3V
53	GNDREF	GND	Ground pin for the REF outputs.
54	X1	IN	Crystal input, nominally 14.318MHz
55	X2	OUT	Crystal output, nominally 14.318MHz
56	VDD48	PWR	Power pin for the 48MHz outputs and core. 3.3V

## General Description

The **ICS9EPRS475** is a main clock synthesizer chip that provides all clocks required for AMD embedded systems. An SMBus interface allows full control of the device.

## Block Diagram

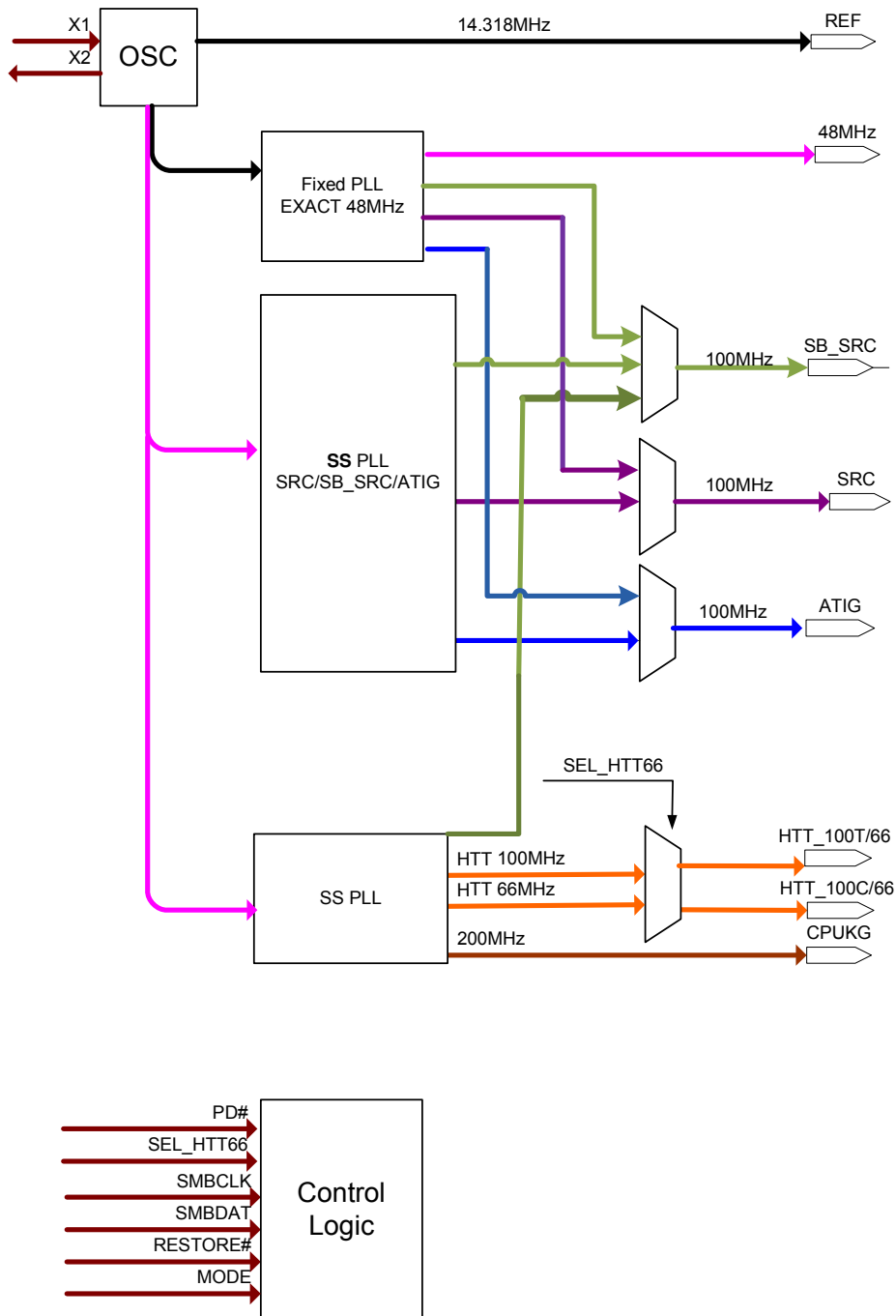


Table1: CPU and HTT Frequency Selection Table

Byte 3					CPU (MHz)	HTT Single- ended SEL_HTT66 = 1	HTT or SB_SRC Differential SEL_HTT66 = 0	SB_SRC (MHz)	Spread %	CPU OverClock %	CPU Output Divider	VCO
Bit5	Bit4	Bit3	Bit1	Bit0								
CPU FS4	CPU FS3	CPU FS2	CPU FS1	CPU FS0								
0	0	0	0	0	133.33	44.44	66.67	66.67	-0.5%	-33%	3	400.00
0	0	0	0	1	137.78	45.93	68.89	68.89		-31%	3	413.33
0	0	0	1	0	142.22	47.41	71.11	71.11		-29%	3	426.67
0	0	0	1	1	146.67	48.89	73.33	73.33		-27%	3	440.00
0	0	1	0	0	151.11	50.37	75.56	75.56		-24%	3	453.33
0	0	1	0	1	155.56	51.85	77.78	77.78		-22%	3	466.67
0	0	1	1	0	160.00	53.33	80.00	80.00		-20%	3	480.00
0	0	1	1	1	164.44	54.81	82.22	82.22		-18%	3	493.33
0	1	0	0	0	168.89	56.30	84.44	84.44		-16%	3	506.67
0	1	0	0	1	173.33	57.78	86.67	86.67		-13%	3	520.00
0	1	0	1	0	177.78	59.26	88.89	88.89		-11%	3	533.33
0	1	0	1	1	182.22	60.74	91.11	91.11		-9%	3	546.67
0	1	1	0	0	186.67	62.22	93.33	93.33		-7%	3	560.00
0	1	1	0	1	191.11	63.70	95.56	95.56		-4%	3	573.33
0	1	1	1	0	195.56	65.19	97.78	97.78		-2%	3	586.67
<b>0</b>	<b>1</b>	<b>1</b>	<b>1</b>	<b>1</b>	<b>200.00</b>	<b>66.67</b>	<b>100.00</b>	<b>100.00</b>	<b>Off</b>	<b>0%</b>	<b>3</b>	<b>600.00</b>
1	0	0	0	0	200.00	66.67	100.00	100.00	-0.50%	0%	3	600.00
1	0	0	0	1	206.25	68.75	103.13	103.13	-0.50%	3%	3	618.75
1	0	0	1	0	212.50	70.83	106.25	106.25		6%	3	637.50
1	0	0	1	1	218.75	72.92	109.38	109.38		9%	3	656.25
1	0	1	0	0	225.00	75.00	112.50	112.50		13%	3	675.00
1	0	1	0	1	231.25	77.08	115.63	115.63		16%	3	693.75
1	0	1	1	0	237.50	79.17	118.75	118.75		19%	3	712.50
1	0	1	1	1	243.75	81.25	121.88	121.88		22%	3	731.25
1	1	0	0	0	250.00	83.33	125.00	125.00		25%	3	750.00
1	1	0	0	1	256.25	85.42	128.13	128.13		28%	3	768.75
1	1	0	1	0	262.50	87.50	131.25	131.25		31%	3	787.50
1	1	0	1	1	268.75	89.58	134.38	134.38		34%	3	806.25
1	1	1	0	0	275.00	91.67	137.50	137.50		38%	3	825.00
1	1	1	0	1	281.25	93.75	140.63	140.63		41%	3	843.75
1	1	1	1	0	287.50	95.83	143.75	143.75		44%	3	862.50
1	1	1	1	1	293.75	97.92	146.88	146.88		47%	3	881.25

Table 2: SRC Frequency Selection Table

Byte 4					SRC (MHz)	ATIG(3:0) (MHz)	SB_SRC (1:0) (MHz)	Spread %	OverClo ck %	SRC Output Divider	VCO (MHz)
Bit4 SB FS4	Bit3 SB FS3	Bit2 SB FS2	Bit1 SB FS1	Bit0 SB FS0							
0	0	0	0	0	87.00	87.00	87.00	-0.48 max	-13%	10	870.00
0	0	0	0	1	87.87	87.87	87.87		-12%	10	878.70
0	0	0	1	0	88.73	88.73	88.73		-11%	10	887.30
0	0	0	1	1	89.60	89.60	89.60		-10%	10	896.00
0	0	1	0	0	90.47	90.47	90.47		-10%	10	904.70
0	0	1	0	1	91.33	91.33	91.33		-9%	10	913.30
0	0	1	1	0	92.20	92.20	92.20		-8%	10	922.00
0	0	1	1	1	93.07	93.07	93.07		-7%	10	930.70
0	1	0	0	0	93.93	93.93	93.93		-6%	10	939.30
0	1	0	0	1	94.80	94.80	94.80		-5%	10	948.00
0	1	0	1	0	95.67	95.67	95.67		-4%	10	956.70
0	1	0	1	1	95.67	95.67	95.67		-4%	10	956.70
0	1	1	0	0	97.40	97.40	97.40		-3%	10	974.00
0	1	1	0	1	98.27	98.27	98.27		-2%	10	982.70
0	1	1	1	0	99.13	99.13	99.13		-1%	10	991.30
<b>0</b>	<b>1</b>	<b>1</b>	<b>1</b>	<b>1</b>	<b>100.00</b>	<b>100.00</b>	<b>100.00</b>		<b>Off</b>	<b>0%</b>	<b>10</b>
1	0	0	0	0	100.00	100.00	100.00	-0.48 max	0%	10	1000.00
1	0	0	0	1	100.87	100.87	100.87		1%	10	1008.70
1	0	0	1	0	101.73	101.73	101.73		2%	10	1017.30
1	0	0	1	1	102.60	102.60	102.60		3%	10	1026.00
1	0	1	0	0	103.47	103.47	103.47		3%	10	1034.70
1	0	1	0	1	104.33	104.33	104.33		4%	10	1043.30
1	0	1	1	0	105.20	105.20	105.20		5%	10	1052.00
1	0	1	1	1	106.07	106.07	106.07		6%	10	1060.70
1	1	0	0	0	106.93	106.93	106.93		7%	10	1069.30
1	1	0	0	1	107.80	107.80	107.80		8%	10	1078.00
1	1	0	1	0	108.67	108.67	108.67		9%	10	1086.70
1	1	0	1	1	109.53	109.53	109.53		10%	10	1095.30
1	1	1	0	0	110.40	110.40	110.40		10%	10	1104.00
1	1	1	0	1	111.27	111.27	111.27		11%	10	1112.70
1	1	1	1	0	112.13	112.13	112.13		12%	10	1121.30
1	1	1	1	1	113.00	113.00	113.00		13%	10	1130.00

NOTE: All frequencies assume that the SRC / SB\_SRC / ATIG are at 0% Overclocking.

## General SMBus serial interface information for the ICS9EPRS475

### How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address  $D2_{(H)}$
- ICS clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- ICS clock will **acknowledge**
- Controller (host) sends the data byte count = X
- ICS clock will **acknowledge**
- Controller (host) starts sending **Byte N through Byte N + X - 1**  
(see Note 2)
- ICS clock will **acknowledge** each byte **one at a time**
- Controller (host) sends a Stop bit

### How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the write address  $D2_{(H)}$
- ICS clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- ICS clock will **acknowledge**
- Controller (host) will send a separate start bit.
- Controller (host) sends the read address  $D3_{(H)}$
- ICS clock will **acknowledge**
- ICS clock will send the data byte count = X
- ICS clock sends **Byte N + X - 1**
- ICS clock sends **Byte 0 through byte X (if  $X_{(H)}$  was written to byte 8)**.
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

Index Block Write Operation		
Controller (Host)		ICS (Slave/Receiver)
T	starT bit	
Slave Address $D2_{(H)}$		
WR	WRite	
		ACK
Beginning Byte = N		
		ACK
Data Byte Count = X		
		ACK
Beginning Byte N	X Byte	
○		ACK
○		○
○		○
Byte N + X - 1		○
		ACK
P	stoP bit	

Index Block Read Operation		
Controller (Host)		ICS (Slave/Receiver)
T	starT bit	
Slave Address $D2_{(H)}$		
WR	WRite	
		ACK
Beginning Byte = N		
		ACK
RT	Repeat starT	
Slave Address $D3_{(H)}$		
RD	ReaD	
		ACK
		Data Byte Count = X
ACK		
		Beginning Byte N
ACK		
○		○
○		○
○		○
		Byte N + X - 1
N	Not acknowledge	
P	stoP bit	



SMBus Table: Latched Input Readback Output Enable Control Register

Byte	0	Name	Description	X.3	0	1	Default
Bit 7	SEL_HTT66 readback		Hypertransport Select	R	100MHz Differential HTT clock	66 MHz 3.3V Single-ended HTT clock	Latch
Bit 6	Reserved						0
Bit 5	REF0_OE		Output Enable	RW	Low	Enabled	1
Bit 4	REF1_OE		Output Enable	RW	Low	Enabled	1
Bit 3	REF2_OE		Output Enable	RW	Low	Enabled	1
Bit 2	48MHz_1_OE		Output Enable	RW	Low	Enabled	1
Bit 1	48MHz_0_OE		Output Enable	RW	Low	Enabled	1
Bit 0	SS_Enable		Spread Spectrum Enable (CPU, HTT)	RW	Spread Off	Spread On	0

SMBus Table: Output Enable Control Register

Byte	1	Name	Control Function	Type	0	1	Default
Bit 7	CPU1_OE		Output enable	RW	Low/Low	Enable	1
Bit 6	CPU0_OE		Output enable	RW	Low/Low	Enable	1
Bit 5	SRC3_OE		Output Enable	RW	Low/Low	Enabled	1
Bit 4	SRC2_OE		Output Enable	RW	Low/Low	Enabled	1
Bit 3	HTT100_OE		Output Enable	RW	Low/Low	Enabled	1
Bit 2	SRC1_OE		Output Enable	RW	Low/Low	Enabled	1
Bit 1	Reserved						1
Bit 0	SRC0_OE		Output Enable	RW	Low/Low	Enabled	1

SMBus Table: Output Enable and 48MHz Strength Control Register

Byte	2	Name	Control Function	Type	0	1	Default
Bit 7	SB_SRC1_OE		Output Enable	RW	Low/Low	Enabled	1
Bit 6	SB_SRC0_OE		Output Enable	RW	Low/Low	Enabled	1
Bit 5	SRC_PLL_SS_Enable		Spread Spectrum Enable (SRC, SB_SRC, ATIG)	RW	Spread Off	Spread On	0
Bit 4	ATIG2_OE		Output Enable	RW	Low/Low	Enabled	1
Bit 3	ATIG1_OE		Output Enable	RW	Low/Low	Enabled	1
Bit 2	ATIG0_OE		Output Enable	RW	Low/Low	Enabled	1
Bit 1	48MHz_1_Strength		48MHz_1 Drive Strength Sel.	RW	1 Load	2 Load	1
Bit 0	48MHz_0_Strength		48MHz_0 Drive Strength Sel.	RW	1 Load	2 Load	1

SMBus Table: CPU/HTT Frequency Control Register

Byte	3	Name	Control Function	Type	0	1	Default
Bit 7	Reserved						0
Bit 6	Reserved						0
Bit 5	Reserved						0
Bit 4	CPU_FS4		CPU Frequency Select MSB	RW	See CPU Frequency Select Table Default value corresponds to 200MHz. Note that Selected HTT frequency tracks the CPU frequency.		0
Bit 3	CPU_FS3		CPU Frequency Select	RW			1
Bit 2	CPU_FS2		CPU Frequency Select	RW			1
Bit 1	CPU_FS1		CPU Frequency Select	RW			1
Bit 0	CPU_FS0		CPU Frequency Select LSB	RW			1

SMBus Table: SRC Frequency Control Register

Byte	4	Name	Control Function	Type	0	1	Default
Bit 7	REF0_Strength		REF0_Drive Strength Sel	RW	1 Load	2 Load	1
Bit 6	REF1_Strength		REF1_Drive Strength Sel	RW	1 Load	2 Load	1
Bit 5	REF2_Strength		REF2_Drive Strength Sel	RW	1 Load	2 Load	1
Bit 4	SRC_FS4		SRC Frequency Select MSB	RW	See SRC Frequency Select Table Note: SB_SRC and ATIG Clocks are synchronous to these outputs. Changing this frequency will alter the SB_SRC and ATIG frequency by the same percentage.		0
Bit 3	SRC_FS3		SRC Frequency Select	RW			1
Bit 2	SRC_FS2		SRC Frequency Select	RW			1
Bit 1	SRC_FS1		SRC Frequency Select	RW			1
Bit 0	SRC_FS0		SRC Frequency Select LSB	RW			1

SMBus Table: Reserved

Byte	5	Name	Control Function	Type	0	1	Default
Bit 7			Reserved				0
Bit 6			Reserved				0
Bit 5			Reserved				0
Bit 4			Reserved				0
Bit 3			Reserved				1
Bit 2			Reserved				1
Bit 1			Reserved				1
Bit 0			Reserved				1

SMBus Table: Reserved

Byte	6	Name	Control Function	Type	0	1	Default
Bit 7			Reserved				0
Bit 6			Reserved				0
Bit 5			Reserved				0
Bit 4			Reserved				0
Bit 3			Reserved				1
Bit 2			Reserved				1
Bit 1		HTT66M_OE_1	Output Enable	RW	Low/Low	Enable	1
Bit 0		HTT66M_OE_0	Output Enable	RW	Low/Low	Enable	1

SMBus Table: Device ID register

Byte	7	Name	Control Function	Type	0	1	Default
Bit 7		Device ID7	Device ID	R	70 hex		0
Bit 6		Device ID6		R			1
Bit 5		Device ID5		R			1
Bit 4		Device ID4		R			1
Bit 3		Device ID3		R			0
Bit 2		Device ID2		R			0
Bit 1		Device ID1		R			0
Bit 0		Device ID0		R			0

SMBus Table: Vendor &amp; Revision ID Register

Byte	8	Name	Control Function	Type	0	1	Default
Bit 7		RID3	REVISION ID	R	-	-	0
Bit 6		RID2		R	-	-	0
Bit 5		RID1		R	-	-	1
Bit 4		RID0		R	-	-	0
Bit 3		VID3	VENDOR ID	R	-	-	0
Bit 2		VID2		R	-	-	0
Bit 1		VID1		R	-	-	0
Bit 0		VID0		R	-	-	1

SMBus Table: WatchDog Timer Control Register

Byte	9	Name	Control Function	Type	0	1	Default
Bit 7		HWD_EN	Watchdog Hard Alarm Enable	RW	Disable and Reload	Enable Timer	0
Bit 6			Reserved				0
Bit 5		WD Hard Status	WD Hard Alarm Status	R	Normal	Alarm	X
Bit 4		WDTCtrl	Watch Dog Alarm Time base Control	RW	290ms Base	1160ms Base	0
Bit 3		HWD3	WD Hard Alarm Timer Bit 3	RW	These bits represent the number of Watch Dog Time Base Units that pass before the Watch Alarm expires. Default is 7 x 290 ms = 2s		0
Bit 2		HWD2	WD Hard Alarm Timer Bit 2	RW			1
Bit 1		HWD1	WD Hard Alarm Timer Bit 1	RW			1
Bit 0		HWD0	WD Hard Alarm Timer Bit 0	RW			1

SMBus Table: Reserved

Byte	10	Name	Control Function	Type	0	1	Default
Bit 7							Reserved
Bit 6							Reserved
Bit 5							Reserved
Bit 4							Reserved
Bit 3							Reserved
Bit 2							Reserved
Bit 1							Reserved
Bit 0							Reserved

SMBus Table: Byte Count Register

Byte	11	Name	Control Function	Type	0	1	Default
Bit 7							Reserved
Bit 6							Reserved
Bit 5		BC5	Byte Count bit 5 (MSB)	RW	Determines the number of bytes that are read back from the device. Default is 0F hex.		0
Bit 4		BC4	Byte Count bit 4	RW		0	
Bit 3		BC3	Byte Count bit 3	RW		1	
Bit 2		BC2	Byte Count bit 2	RW		1	
Bit 1		BC1	Byte Count bit 1	RW		1	
Bit 0		BC0	Byte Count bit 0 (LSB)	RW		1	

SMBus Table: M/N Programming Enable and I/O Vout Control Register

Byte	12	Name	Control Function	Type	0	1	Default
Bit 7		CPU M/N En	CPU PLL M/N Prog. Enable	RW	M/N Prog. Disabled	M/N Prog. Enabled	0
Bit 6		SRC M/N En	SRC M/N Prog. Enable	RW	M/N Prog. Disabled	M/N Prog. Enabled	0
Bit 5		SKIP_N_INC	Skip N Incrementing during CPU PLL M/N Programming	RW	N-Increment	Bypass N-Increment	0
Bit 4							Reserved
Bit 3							Reserved
Bit 2		IO_VOUT2	IO Output Voltage Select (Most Significant Bit)	RW	See Table 5: V_IO Selection (Default is 0.8V)		1
Bit 1		IO_VOUT1	IO Output Voltage Select	RW		0	
Bit 0		IO_VOUT0	IO Output Voltage Select (Least Significant Bit)	RW		1	

SMBus Table: Reserved Register

Byte	13	Name	Control Function	Type	0	1	Default
Bit 7							Reserved
Bit 6							Reserved
Bit 5							Reserved
Bit 4							Reserved
Bit 3							Reserved
Bit 2							Reserved
Bit 1							Reserved
Bit 0							Reserved

SMBus Table: Reserved Register

Byte	14	Name	Control Function	Type	0	1	Default
Bit 7		CPU NDiv0	LSB N Divider Programming	RW	Byte 27 has the N Divider LSB (bit 0) for CPU		X
Bit 6							Reserved
Bit 5							Reserved
Bit 4							Reserved
Bit 3		SB_SRCDiv3	SB_SRC Divider Ratio Programming Bits from CPU PLL	RW	0000:/2 ; 0100:/4	1000:/8 ; 1100:/16	X
Bit 2		SB_SRCDiv2		RW	0001:/3 ; 0101:/6	1001:/12 ; 1101:/24	X
Bit 1		SB_SRCDiv1		RW	0010:/5 ; 0110:/10	1010:/20 ; 1110:/40	X
Bit 0		SB_SRCDiv0		RW	0011:/9 ; 0111:/18	1011:/36 ; 1111:/72	X

SMBus Table: Test Mode Register

Byte	15	Name	Control Function	Type	0	1	Default
Bit 7		Test_Md_Sel	Selects Test Mode	RW	Normal mode	All outputs are REF/N	0
Bit 6			Reserved				0
Bit 5			Reserved				0
Bit 4			Reserved				0
Bit 3			Reserved				0
Bit 2			Reserved				0
Bit 1			Reserved				0
Bit 0			Reserved				0

SMBus Table: CPU PLL Frequency Control Register

Byte	16	Name	Control Function	Type	0	1	Default
Bit 7		N Div2	N Divider Prog bit 2	RW	The decimal representation of M and N Divider in Byte 16 and 17 will configure the VCO frequency. Default at power up = Byte 0 Rom table. See M/N Calculation Tables for VCO frequency formulas.		X
Bit 6		N Div1	N Divider Prog bit 1	RW			X
Bit 5		M Div5	M Divider Programming bits	RW			X
Bit 4		M Div4		RW			X
Bit 3		M Div3		RW			X
Bit 2		M Div2		RW			X
Bit 1		M Div1		RW			X
Bit 0		M Div0		RW			X

SMBus Table: CPU PLL Frequency Control Register

Byte	17	Name	Control Function	Type	0	1	Default
Bit 7		N Div10	N Divider Programming b(10:3)	RW	The decimal representation of M and N Divider in Byte 16 and 17 will configure the VCO frequency. Default at power up = Byte 0 Rom table. See M/N Calculation Tables for VCO frequency formulas.		X
Bit 6		N Div9		RW			X
Bit 5		N Div8		RW			X
Bit 4		N Div7		RW			X
Bit 3		N Div6		RW			X
Bit 2		N Div5		RW			X
Bit 1		N Div4		RW			X
Bit 0		N Div3		RW			X

SMBus Table: CPU PLL Spread Spectrum Control Register

Byte	18	Name	Control Function	Type	0	1	Default
Bit 7			Reserved				1
Bit 6			Reserved				0
Bit 5			Reserved				0
Bit 4			Reserved				0
Bit 3		SB_SRC_Ssel	SB_SRC PLL Source Selection (MSB)	RW	10 - N/A	11 - CPU PLL	0
Bit 2		ATIG_Ssel	ATIGCLK PLL Source Selection	RW	SRC PLL	FIX PLL	0
Bit 1		SRC_Ssel	SRC PLL Source Selection	RW	SRC PLL	FIX PLL	0
Bit 0		SB_SRC_Ssel	SB_SRC PLL Source Selection (LSB)	RW	00 - SRC PLL	01 - FIX PLL	0

SMBus Table: Reserved

Byte	19	Name	Control Function	Type	0	1	Default
Bit 7			Reserved				0
Bit 6			Reserved				0
Bit 5			Reserved				0
Bit 4			Reserved				0
Bit 3			Reserved				0
Bit 2			Reserved				0
Bit 1			Reserved				0
Bit 0			Reserved				0

**SMBUS Table: SRC spread enable**

Byte	20	Name	Control Function	Type	0	1	Default
Bit 7		SRC_PLL_SS_Enable	Spread Spectrum Enable (SRC, SB_SRC, ATIG)	RW	Spread Off	Spread On	0
Bit 6			Reserved				0
Bit 5			Reserved				0
Bit 4			Reserved				0
Bit 3			Reserved				0
Bit 2			Reserved				0
Bit 1			Reserved				0
Bit 0			Reserved				0

**SMBUS Table: Reserved**

Byte	21	Name	Control Function	Type	0	1	Default
Bit 7			Reserved				0
Bit 6			Reserved				0
Bit 5			Reserved				0
Bit 4			Reserved				0
Bit 3			Reserved				0
Bit 2			Reserved				0
Bit 1			Reserved				0
Bit 0			Reserved				0

**SMBUS Table: Reserved**

Byte	22	Name	Control Function	Type	0	1	Default
Bit 7		ATIGDiv3	ATIG Divider Ratio Programming Bits	RW	0000:/2 ; 0100:/4	1000:/8 ; 1100:/16	X
Bit 6		ATIGDiv2		RW	N/A ; 0101:/6	1001:/12 ; 1101:/24	X
Bit 5		ATIGDiv1		RW	N/A ; 0110:/10	1010:/20 ; 1110:/40	X
Bit 4		ATIGDiv0		RW	N/A ; 0111:/14	1011:/28 ; 1111:/56	X
Bit 3		SB_SRCDiv3	SB_SRC Divider Ratio Programming Bits from SRC Fixed / PLL	RW	0000:/2 ; 0100:/4	1000:/8 ; 1100:/16	X
Bit 2		SB_SRCDiv2		RW	0001:/3 ; 0101:/6	1001:/12 ; 1101:/24	X
Bit 1		SB_SRCDiv1		RW	0010:/5 ; 0110:/10	1010:/20 ; 1110:/40	X
Bit 0		SB_SRCDiv0		RW	0011:/7 ; 0111:/14	1011:/28 ; 1111:/56	X

**SMBUS Table: SRC Spread Spectrum Control Register**

Byte	23	Name	Control Function	Type	0	1	Default
Bit 7		SSP7	Spread Spectrum Programming bit(7:0)	RW	These bits set the SRC, the ATIG and SB_SRC spread percentages. Please contact ICS for the appropriate values.		X
Bit 6		SSP6		RW			X
Bit 5		SSP5		RW			X
Bit 4		SSP4		RW			X
Bit 3		SSP3		RW			X
Bit 2		SSP2		RW			X
Bit 1		SSP1		RW			X
Bit 0		SSP0		RW			X

**SMBUS Table: SRC Spread Spectrum Control Register**

Byte	24	Name	Control Function	Type	0	1	Default
Bit 7		SSP15	Spread Spectrum Programming bit(15:8)	RW	These bits set the SRC, the ATIG and SB_SRC spread percentages. Please contact ICS for the appropriate values.		X
Bit 6		SSP14		RW			X
Bit 5		SSP13		RW			X
Bit 4		SSP12		RW			X
Bit 3		SSP11		RW			X
Bit 2		SSP10		RW			X
Bit 1		SSP9		RW			X
Bit 0		SSP8		RW			X

SMBUS Table: SRC Frequency Control Register

Byte	25	Name	Control Function	Type	0	1	Default
Bit 7		N Div2	N Divider Prog bit 2	RW	The decimal representation of M and N Divider in Byte 20 and 21 configure the SRC VCO frequency. See M/N Calculation Tables for VCO frequency formulas.  NOTE: Changing this frequency will also alter the ATIG and SB_SRC frequencies by a similar amount.		X
Bit 6		N Div1	N Divider Prog bit 1	RW			X
Bit 5		M Div5	M Divider Programming bit (5:0)	RW			X
Bit 4		M Div4		RW			X
Bit 3		M Div3		RW			X
Bit 2		M Div2		RW			X
Bit 1		M Div1		RW			X
Bit 0		M Div0		RW			X

SMBUS Table: SRC Frequency Control Register

Byte	26	Name	Control Function	Type	0	1	Default
Bit 7		N Div10	N Divider Programming Byte16 bit(7:0) and Byte15 bit(7:6)	RW	The decimal representation of M and N Divider in Byte 20 and 21 configure the SRC VCO frequency. See M/N Calculation Tables for VCO frequency formulas.  NOTE: Changing this frequency will also alter the ATIG and SB_SRC frequencies by a similar amount.		X
Bit 6		N Div9		RW			X
Bit 5		N Div8		RW			X
Bit 4		N Div7		RW			X
Bit 3		N Div6		RW			X
Bit 2		N Div5		RW			X
Bit 1		N Div4		RW			X
Bit 0		N Div3		RW			X

SMBUS Table: CPU Output Divider Control Register

Byte	27	Name	Control Function	Type	0	1	Default
Bit 7		HTTDiv3	HTT Divider Ratio Programming Bits	RW	0000:/2 ; 0100:/4	1000:/8 ; 1100:/16	X
Bit 6		HTTDiv2		RW	N/A ; 0101:/6	1001:/12 ; 1101:/24	X
Bit 5		HTTDiv1		RW	N/A ; 0110:/10	1010:/20 ; 1110:/40	X
Bit 4		HTTDiv0		RW	N/A ; 0111:/18	1011:/36 ; 1111:/72	X
Bit 3		CPUDiv3	CPU Divider Ratio Programming Bits	RW	0000:/2 ; 0100:/4	1000:/8 ; 1100:/16	X
Bit 2		CPUDiv2		RW	0001:/3 ; 0101:/6	1001:/12 ; 1101:/24	X
Bit 1		CPUDiv1		RW	0010:/5 ; 0110:/10	1010:/20 ; 1110:/40	X
Bit 0		CPUDiv0		RW	0011:/9 ; 0111:/18	1011:/36 ; 1111:/72	X

SMBUS Table: CPU PLL Spread Spectrum Control Register

Byte	28	Name	Control Function	Type	0	1	Default
Bit 7		SSP7	Spread Spectrum Programming b(7:0)	RW	These bits set the CPU/HTT spread percentage. Please contact ICS for the appropriate values.		X
Bit 6		SSP6		RW			X
Bit 5		SSP5		RW			X
Bit 4		SSP4		RW			X
Bit 3		SSP3		RW			X
Bit 2		SSP2		RW			X
Bit 1		SSP1		RW			X
Bit 0		SSP0		RW			X

SMBUS Table: CPU PLL Spread Spectrum Control Register

Byte	29	Name	Control Function	Type	0	1	Default
Bit 7		SSP15	Spread Spectrum Programming b(15:8)	RW	These bits set the CPU/HTT spread percentage. Please contact ICS for the appropriate values.		X
Bit 6		SSP14		RW			X
Bit 5		SSP13		RW			X
Bit 4		SSP12		RW			X
Bit 3		SSP11		RW			X
Bit 2		SSP10		RW			X
Bit 1		SSP9		RW			X
Bit 0		SSP8		RW			X

SMBUS Table: SRC Output Divider Control Register

Byte	30	Name	Control Function	Type	0	1	Default
Bit 7		SRC NDiv0	LSB N Divider Programming	RW	Byte 30 has the N Divider LSB (bit 0) for SRC		X
Bit 6			Reserved				X
Bit 5			Reserved				X
Bit 4			Reserved				X
Bit 3		SRCDiv3	SRC Divider Ratio Programming Bits	RW	0000:/2 ; 0100:/4	1000:/8 ; 1100:/16	X
Bit 2		SRCDiv2		RW	N/A ; 0101:/6	1001:/12 ; 1101:/24	X
Bit 1		SRCDiv1		RW	N/A; 0110:/10	1010:/20 ; 1110:/40	X
Bit 0		SRCDiv0		RW	N/A; 0111:/14	1011:/28 ; 1111:/56	X

SMBUS Table: Reserved Register

Byte	31	Name	Control Function	Type	0	1	Default
Bit 7			Reserved				X
Bit 6			Reserved				X
Bit 5			Reserved				X
Bit 4			Reserved				X
Bit 3			Reserved				X
Bit 2			Reserved				X
Bit 1			Reserved				X
Bit 0			Reserved				X

## Absolute Maximum Rating

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	Notes
3.3V Core Supply Voltage	VDDxxx	-		3.3	GND + 3.9V	V	1
Storage Temperature	T <sub>s</sub>	-	-65		150	°C	1
Ambient Operating Temp	T <sub>ambient</sub>	-	0		70	°C	1
Case Temperature	T <sub>case</sub>	-			115	°C	1
Input ESD protection HBM	ESD prot	-	2000			V	1

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

## Electrical Characteristics - Input/Supply/Common Output Parameters

PARAMETER	SYMBOL	CONDITIONS*	MIN	TYP	MAX	UNITS	Notes
3.3V Core Supply Voltage	VDDxxx	-	3.135	3.3	3.465	V	1
Input High Voltage	V <sub>IH</sub>	VDD = 3.3 V +/-5%	2		V <sub>DD</sub> + 0.3	V	1
Input Low Voltage	V <sub>IL</sub>	VDD = 3.3 V +/-5%	V <sub>SS</sub> - 0.3		0.8	V	1
Input High Current	I <sub>IH</sub>	V <sub>IN</sub> = V <sub>DD</sub>	-5		5	uA	1
Input Low Current	I <sub>IL1</sub>	V <sub>IN</sub> = 0 V; Inputs with no pull-up resistors	-5			uA	1
	I <sub>IL2</sub>	V <sub>IN</sub> = 0 V; Inputs with pull-up resistors	-200			uA	1
Low Threshold Input-High Voltage	V <sub>IH_FS</sub>	VDD = 3.3 V +/-5%	0.7		V <sub>DD</sub> + 0.3	V	1
Low Threshold Input-Low Voltage	V <sub>IL_FS</sub>	VDD = 3.3 V +/-5%	V <sub>SS</sub> - 0.3		0.35	V	1
Operating Current	I <sub>DD3.30P</sub>	3.3V VDD current, all outputs driven			115	mA	1
Powerdown Current	I <sub>DD3.3PD</sub>	all diff pairs low/low			12	mA	1
Input Frequency	F <sub>i</sub>	VDD = 3.3 V +/-5%		14.31818		MHz	2
Pin Inductance	L <sub>pin</sub>				7	nH	1
Input Capacitance	C <sub>IN</sub>	Logic Inputs			5	pF	1
	C <sub>OUT</sub>	Output pin capacitance			6	pF	1
	C <sub>INX</sub>	X1 & X2 pins			5	pF	1
Clk Stabilization	T <sub>STAB</sub>	From VDD Power-Up or de-assertion of PD to 1st clock			1.8	ms	1
Modulation Frequency		Triangular Modulation	30		33	kHz	1
Tdrive_PD		CPU output enable after PD de-assertion			300	us	1
Tfall_PD		PD fall time of			5	ns	1
Trise_PD		PD rise time of			5	ns	1
SMBus Voltage	V <sub>DDSMB</sub>		2.7		5.5	V	1
Low-level Output Voltage	V <sub>OLSMB</sub>	@ I <sub>PULLUP</sub>			0.4	V	1
Current sinking at V <sub>OL</sub> = 0.4 V	I <sub>PULLUPSMB</sub>		4	6		mA	1
SMBCLK/SMBDAT Clock/Data Rise Time	T <sub>RSMB</sub>	(Max VIL - 0.15) to (Min VIH + 0.15)			1000	ns	1
SMBCLK/SMBDAT Clock/Data Fall Time	T <sub>FSMB</sub>	(Min VIH + 0.15) to (Max VIL - 0.15)			300	ns	1

\*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup>Input frequency should be measured at the REF pin and tuned to ideal 14.31818MHz to meet ppm frequency accuracy on PLL outputs.



**AC Electrical Characteristics - Low-Power DIF Outputs: CPUKG and HTT**

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Crossing Point Variation	$\Delta V_{\text{CROSS}}$	Single-ended Measurement			140	mV	1,2,5
Frequency	f	Spread Specturm On	198.8		200	MHz	1,3
Long Term Accuracy	ppm	Spread Specturm Off	-300		+300	ppm	1,11
Rising Edge Slew Rate	$S_{\text{RISE}}$	Differential Measurement	0.5		10	V/ns	1,4
Falling Edge Slew Rate	$S_{\text{FALL}}$	Differential Measurement	0.5		10	V/ns	1,4
Slew Rate Variation	$t_{\text{SLVAR}}$	Single-ended Measurement			20	%	1
CPU, DIF HTT Jitter - Cycle to Cycle	$\text{CPUJ}_{\text{C2C}}$	Differential Measurement			150	ps	1,6
Accumulated Jitter	$t_{\text{JACC}}$	See Notes			1	ns	1,7
Peak to Peak Differential Voltage	$V_{\text{D(PK-PK)}}$	Differential Measurement	400		2400	mV	1,8
Differential Voltage	$V_{\text{D}}$	Differential Measurement	200		1200	mV	1,9
Duty Cycle	$D_{\text{CYC}}$	Differential Measurement	45		55	%	1
Amplitude Variation	$\Delta V_{\text{D}}$	Change in $V_{\text{D}}$ DC cycle to cycle	-75		75	mV	1,10
CPU[1:0] Skew	$\text{CPU}_{\text{SKEW10}}$	Differential Measurement			100	ps	1

**Notes on Electrical Characteristics:**

Guaranteed by design and characterization, not 100% tested in production.

Single-ended measurement at crossing point. Value is maximum – minimum over all time. DC value of common mode is not important due to the blocking cap.

Minimum Frequency is a result of 0.5% down spread spectrum

Differential measurement through the range of  $\pm 100$  mV, differential signal must remain monotonic and within slew rate spec when crossing through this region.

<sup>5</sup> Defined as the total variation of all crossing voltages of CLK rising and CLK# falling. Matching applies to rising edge rate of CLK and falling edge of CLK#. It is measured using a  $\pm 75$ mV window centered on the average cross point where CLK meets CLK#.

<sup>6</sup> Max difference of  $t_{\text{CYCLE}}$  between any two adjacent cycles.

<sup>7</sup> Accumulated  $t_{\text{jc}}$  over a 10  $\mu\text{s}$  time period, measured with J1T2 TIE at 50ps interval.

<sup>8</sup>  $V_{\text{D(PK-PK)}}$  is the overall magnitude of the differential signal.

<sup>9</sup>  $V_{\text{D(min)}}$  is the amplitude of the ring-back differential measurement, guaranteed by design, that ring-back will not cross 0V  $V_{\text{D}}$ .  $V_{\text{D(max)}}$  is the largest amplitude allowed.

<sup>10</sup> The difference in magnitude of two adjacent  $V_{\text{D\_DC}}$  measurements.  $V_{\text{D\_DC}}$  is the stable post overshoot and ring-back part of the signal.

<sup>11</sup> All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 14.31818MHz

**AC Electrical Characteristics - Low-Power DIF Outputs: SRC, SB\_SRC, ATIG**

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Rising Edge Slew Rate	$t_{SLR}$	Differential Measurement	0.6		4	V/ns	1,2
Falling Edge Slew Rate	$t_{FLR}$	Differential Measurement	0.6		4	V/ns	1,2
Slew Rate Variation	$t_{SLVAR}$	Single-ended Measurement			20	%	1
Maximum Output Voltage	$V_{HIGH}$	Includes overshoot			1150	mV	1
Minimum Output Voltage	$V_{LOW}$	Includes undershoot	-300			mV	1
Differential Voltage Swing	$V_{SWING}$	Differential Measurement	300			mV	1
Crossing Point Voltage	$V_{XABS}$	Single-ended Measurement	300		550	mV	1,3,4
Crossing Point Variation	$V_{XABSVAR}$	Single-ended Measurement			140	mV	1,3,5
Duty Cycle	$D_{CYC}$	Differential Measurement	45		55	%	1
SRC Jitter - Cycle to Cycle	$SRCJ_{C2C}$	Differential Measurement			125	ps	1
SRC[3:0] Skew	$SRC_{SKEW}$	Differential Measurement			100	ps	1
SB_SRC[1:0] Skew	$SRC_{SKEW}$	Differential Measurement			100	ps	1

**Notes on Electrical Characteristics:**

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup>Slew rate measured through Vswing centered around differential zero

<sup>3</sup>Vxabs is defined as the voltage where CLK = CLK#

<sup>4</sup>Only applies to the differential rising edge (CLK rising and CLK# falling)

<sup>5</sup>Defined as the total variation of all crossing voltages of CLK rising and CLK# falling. Matching applies to rising edge rate of

<sup>6</sup>All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 14.31818MHz

**Electrical Characteristics - Single-ended HTT 66MHz Clock**

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	Notes
Long Accuracy	ppm	see Tperiod min-max values	-300		300	ppm	1,2
PCI33 Clock period	$T_{period}$	33.33MHz output nominal	29.9910		30.0090	ns	2
		33.33MHz output spread	29.9910		30.1598	ns	2
HTT66 Clock period	$T_{period}$	66.67MHz output nominal	14.9955		15.0045	ns	2
		66.67MHz output spread	14.9955		15.0799	ns	2
Output High Voltage	$V_{OH}$	$I_{OH} = -1 \text{ mA}$	2.4			V	1
Output Low Voltage	$V_{OL}$	$I_{OL} = 1 \text{ mA}$			0.55	V	1
Output High Current	$I_{OH}$	$V_{OH} @ \text{MIN} = 1.0 \text{ V}$	-33			mA	1
		$V_{OH} @ \text{MAX} = 3.135 \text{ V}$			-33	mA	1
Output Low Current	$I_{OL}$	$V_{OL} @ \text{MIN} = 1.95 \text{ V}$	30			mA	1
		$V_{OL} @ \text{MAX} = 0.4 \text{ V}$			38	mA	1
Edge Rate	$\delta V/\delta t$	Rising edge rate ( $V_{OL} = 0.4 \text{ V}$ , $V_{OH} = 2.4 \text{ V}$ )	1		4	V/ns	1
Edge Rate	$\delta V/\delta t$	Falling edge rate ( $V_{OL} = 0.4 \text{ V}$ , $V_{OH} = 2.4 \text{ V}$ )	1		4	V/ns	1
Duty Cycle	$d_{t1}$	$V_T = 1.5 \text{ V}$	45		55	%	1
Jitter, Cycle to cycle	$t_{jyc-cyc}$	$V_T = 1.5 \text{ V}$			180	ps	1

\*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%, CL = 5 pF with Rs = 22Ω (unless otherwise specified)

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup>All Long Term Accuracy and Clock Period specifications are guaranteed with the assumption that REF is at 14.31818MHz

## Electrical Characteristics - USB - 48MHz

PARAMETER	SYMBOL	CONDITIONS*	MIN	TYP	MAX	UNITS	NOTES
Long Accuracy	ppm	see Tperiod min-max values	-100		100	ppm	1,2
Clock period	T <sub>period</sub>	48.00MHz output nominal	20.8229		20.8344	ns	2
Clock Low Time	T <sub>low</sub>	Measure from < 0.6V	9.3750		11.4580	ns	2
Clock High Time	T <sub>high</sub>	Measure from > 2.0V	9.3750		11.4580	ns	2
Output High Voltage	V <sub>OH</sub>	I <sub>OH</sub> = -1 mA	2.4			V	1
Output Low Voltage	V <sub>OL</sub>	I <sub>OL</sub> = 1 mA			0.55	V	1
Output High Current	I <sub>OH</sub>	V <sub>OH</sub> @ MIN = 1.0 V	-33			mA	1
		V <sub>OH</sub> @ MAX = 3.135 V			-33	mA	1
Output Low Current	I <sub>OL</sub>	V <sub>OL</sub> @ MIN = 1.95 V	30			mA	1
		V <sub>OL</sub> @ MAX = 0.4 V			38	mA	1
Edge Rate	ΔV/Δt	Rising edge rate (VOL = 0.4 V, VOH = 2.4 V)	1.3		4	V/ns	1
Edge Rate	ΔV/Δt	Falling edge rate (VOL = 0.4 V, VOH = 2.4 V)	1.3		4	V/ns	1
Duty Cycle	d <sub>tt</sub>	V <sub>T</sub> = 1.5 V	45		55	%	1
Group Skew	t <sub>skew</sub>	V <sub>T</sub> = 1.5 V			250	ps	1
Jitter, Cycle to cycle	t <sub>jyc-cyc</sub>	V <sub>T</sub> = 1.5 V			130	ps	1,2

\*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%, CL = 5 pF with Rs = 22Ω (unless otherwise specified)

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup>ICS recommended and/or chipset vendor layout guidelines must be followed to meet this specification

## Electrical Characteristics - REF-14.318MHz

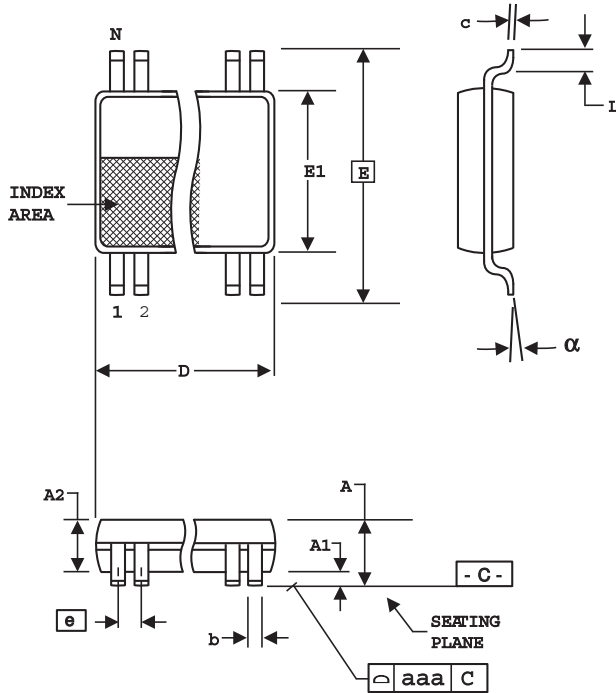
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	Notes
Long Accuracy	ppm	see Tperiod min-max values	-300		300	ppm	1,2
Clock period	T <sub>period</sub>	14.318MHz output nominal	69.8270		69.8550	ns	2
Clock Low Time	T <sub>low</sub>	Measure from < 0.6V	30.9290		37.9130	ns	2
Clock High Time	T <sub>high</sub>	Measure from > 2.0V	30.9290		37.9130	ns	2
Output High Voltage	V <sub>OH</sub>	I <sub>OH</sub> = -1 mA	2.4			V	1
Output Low Voltage	V <sub>OL</sub>	I <sub>OL</sub> = 1 mA			0.4	V	1
Output High Current	I <sub>OH</sub>	V <sub>OH</sub> @ MIN = 1.0 V, V <sub>OH</sub> @ MAX = 3.135 V	-29		-23	mA	1
		V <sub>OL</sub> @ MIN = 1.95 V, V <sub>OL</sub> @ MAX = 0.4 V	29		27	mA	1
Edge Rate	ΔV/Δt	Rising edge rate (VOL = 0.4 V, VOH = 2.4 V)	1.3		2	V/ns	1
Edge Rate	ΔV/Δt	Falling edge rate (VOL = 0.4 V, VOH = 2.4 V)	1.3		2	V/ns	1
Skew	t <sub>sk1</sub>	V <sub>T</sub> = 1.5 V			250	ps	1
Duty Cycle	d <sub>tt</sub>	V <sub>T</sub> = 1.5 V	45		55	%	1
Jitter	t <sub>jyc-cyc</sub>	V <sub>T</sub> = 1.5 V			300	ps	1

\*TA = 0 - 70°C; Supply Voltage VDD = 3.3 V +/-5%, CL = 5 pF with Rs = 22Ω (unless otherwise specified)

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup>All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 14.31818MHz

56-Lead 6.10 mm. Body, 0.50 mm. Pitch TSSOP  
(240 mil) (20 mil)



SYMBOL	In Millimeters COMMON DIMENSIONS		In Inches COMMON DIMENSIONS	
	MIN	MAX	MIN	MAX
A	--	1.20	--	.047
A1	0.05	0.15	.002	.006
A2	0.80	1.05	.032	.041
b	0.17	0.27	.007	.011
c	0.09	0.20	.0035	.008
D	SEE VARIATIONS		SEE VARIATIONS	
E	8.10 BASIC		0.319 BASIC	
E1	6.00	6.20	.236	.244
e	0.50 BASIC		0.020 BASIC	
L	0.45	0.75	.018	.030
N	SEE VARIATIONS		SEE VARIATIONS	
$\alpha$	0°	8°	0°	8°
aaa	--	0.10	--	.004

VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
56	13.90	14.10	.547	.555

Reference Doc.: JEDEC Publication 95, M O-153

10-0039

Ordering Information

Part/Order Number	Shipping Packaging	Package	Temperature
9EPRS475CGLF	Tubes	56-pin TSSOP	0 to 70° C
9EPRS475CGLFT	Tape and Reel	56-pin TSSOP	0 to 70° C

“LF” suffix to the part number are the Pb-Free configuration and are RoHS compliant.

“C” is the device revision designator (will not correlate with the datasheet revision)

Due to package size constraints, actual top-side marking may differ from the full orderable part number.

**Revision History**

Rev.	Issue Date		Description	Page #
0.1	7/31/2009		Initial Release	-
A	8/19/2009	RW	Released to final.	
B	4/26/2010	RW	1. Update part ordering information from "B" to "C" 2. Updated document template.	Various

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